

EHS Japan TC Chapter

Meeting Summary and Minutes

Japan Spring Meetings 2023 Wednesday, April 12, 2023 10:00 – 12:00 [JST] OVTCCM/ SEMI Japan Office, Tokyo, Japan (Hybrid)

TC Chapter Announcements

Next TC Chapter Meeting Thursday, September 7, 2023 10:00-12:00 [JST] OVTCCM/ SEMI Japan Office, Tokyo, Japan (Hybrid)

Table 1 Meeting Attendees

Italics indicate virtual participants.

Co-Chairs: Hidetoshi Sakura/ Nuflare Technology, Moray Crawford/Hatsuta Seisakusho **SEMI Staff:** Akiko Yoshida (SEMI Japan)

Company	Last	First	Company	Last	First
Applied Materials Taiwan	Liu	Shane	Organo	Futatsuki	Takashi
DAIFUKU	Suzuki	Tomoko	Safety Guru	Sklar	Eric
Hatsuta Seisakusho	Crawford	Moray	SCREEN Semiconductor Solution	Nishimura	Takayuki
KOKUSAI ELECTRIC	Matsuda	Mitsuhiro	SEMI Japan	Kanno	Hirofumi
MURATA MACHINERY	Adachi	Naruto	SEMI Japan	Okayasu	Nobuko
Nikon Precision	Girlea	Lucian	SEMI Japan	Yoshida	Akiko
NuFlare Technology	Sakura	Hidetoshi	SGS Japan	Abe	Kenichi
NuFlare Technology	Sato	Yoshiyuki			

Table 2 Leadership Changes

WG/TF/SC/TC Name	Previous Leader	New Leader
None		

Table 3 TC Chapter Structure Changes

Previous WG/TF/SC Name	New WG/TF/SC Name or Status Change	
None		

Table 4 Ballot Results

Document #	Document Title	Committee Action
None		

#1 Passed ballots and line items will be submitted to the ISC Audit & Review Subcommittee for procedural review.

#2 Failed ballots and line items were returned to the originating task forces for re-work and re-balloting or abandoning.



Table 5 Ratification Ballot Results

Document #	Document Title	ISC A&R Action	A&R Forms
None			

Note 1: Passed Ratification ballots will be submitted to SEMI publication for final processing.

Note 2: Failed Ratification ballots were returned to the originating task forces for re-work and re-balloting or abandoning.

Table 6 Activities Approved by the GCS between meetings of the TC Chapter

#	Туре	SC/TF/WG	Details
None			

Table 7 Authorized Activities

Listing of all revised or new SNARF(s) approved by the Originating TC Chapter.

#	Туре	SC/TF/WG	Details
None			

#1 SNARFs and TFOFs are available for review on the SEMI Web site at: http://downloads.semi.org/web/wstdsbal.nsf/TFOFSNARF

Table 8 Authorized Ballots

#	When	TF	Details
7028	Cycle 4 or 5	EHS Japan TC Chapter	Reapproval of SEMI S21-0818, Safety Guideline for Worker Protection

Table 9 SNARF(s) Granted a One-Year Extension

#	TF	Title	Expiration Date
None			

Table 10 SNARF(s) Abolished

#	TF	Title
None		

Table 11 Standard(s) to receive Inactive Status

Standard Designation	Title
None	

Table 12 New Action Items

Item #	Assigned to	Details
EHS20230412-01		To submit the Letter Ballot for reapproval of S21-0818: Safety Guideline for Worker Protection in Cycle 4 or 5.



Table 13 Previous Meeting Action Items

Item #	Assigned to	Details
	JA & NA sides of Global Seismic TF leaders	To discuss the first Global TF meeting with NA Leader, Lauren Crane (Lam Research)- >Open

1 Welcome, Reminders, and Introductions

Moray Crawford (Hatsuta Seisakusho) called the meeting to order at 10:00. The meeting reminders on antitrust issues, intellectual property issues and holding meetings with international attendance were reviewed. Attendees introduced themselves.

Attachment: 01_Meeting Reminders

2 Review of Previous Meeting Minutes

The TC Chapter reviewed the minutes of the previous meeting.

Motion:	Approve the minutes as written.		
By / 2 nd :	Hidetoshi Sakura (NuFlare Technology)/ Lucian Girlea (Nikon Precision)		
Discussion:	None.		
Vote:	9-0. Motion passed.		

Attachment: 02_EHS Japan_Minutes_221215

3 Liaison Reports

3.1 Japan Regional Standards Committee (JRSC) Report

Moray Crawford (Hatsuta Seisakusho) reported for the JRSC that there had been no updates related to EHS from the previous meeting.

3.2 Global Coordinating Subcommittee (GCS) Report

Moray Crawford (Hatsuta Seisakusho) reported for the GCS that there had been no voting or discussion in GCS between meetings of the EHS Japan TC Chapter.

3.3 EHS North America TC Chapter

Eric Sklar (Safety Guru) reported for the EHS NA TC Chapter. Of note:

- S2 Interlocks Design Task Force was disbanded due to its expanded scope. Instead, S2 Major Revision Task Force was formed. The TF considers to issue an informational ballot.
- The S23 Revision Task Force has decided to turn SEMI S23-1021e "Guide for Conservation of Energy, Utilities and Materials Used by Semiconductor Manufacturing Equipment" into a "Test Method" with guidance information in an appendix because of the challenges of transitioning to two documents (an S23 Test Method & a new Guide).

Attachment: 03_NA EHS TC Chapter Liaison report April 2023 v1_es11apr23c



3.4 EHS Taiwan TC Chapter

Akiko Yoshida (SEMI Japan) reported that there had been no updates from the previous meeting.

4 SEMI Staff Report

Akiko Yoshida (SEMI Japan) gave the SEMI Staff Report. Of note:

- Regulations and Procedure Manual were updated in February.
- SEMI University (SEMI Global e-learning platform) was launched in early February 2023 providing 360+ ondemand courses created specifically for the semiconductor industry.

Attachment: 04_Staff Report March 2023 v3

5 Ballot Review

None.

6 Subcommittee and Task Force Reports

6.1 Global Seismic Protection Task Force

Akiko Yoshida (SEMI Japan) reported for the Global Seismic Protection Task Force, on behalf a TF co-leader. The TF has not met as no specific topics were raised after the formation of the Global Task Force from NA side.

6.2 Global S23 Revision Task Force

Please refer to the North America TC Chapter liaison report for the Global S23 Revision Task Force updates.

6.3 S18 Revision Task Force

Akiko Yoshida (SEMI Japan) reported for S18 Revision Task Force, on behalf a TF co-leader. The TF is now considering whether to recruit additional members since the result of recruitment was slow.

6.4 S2 Major Revision Liaison TF Task Force

Akiko Yoshida (SEMI Japan) reported for S2 Major Revision Liaison Task Force, on behalf a TF co-leader. The Japan S2 Major Revision Liaison TF (JA-S2 revision LTF) is now recruiting members. Kick Off meeting will be held in May.

7 Old Business

7.1 Project Period Review

None.

7.2 5-year Review

The EHS Japan EHS TC Chapter co-chairs prepared the new SNARF to reapprove SEMI S21-0818 "Safety Guideline for Worker Protection," and everyone attending the meeting reviewed it.



Motion:	Approve the SNARF to reapprove SEMI S21-0818: Safety Guideline for Worker Protection.		
By / 2 nd :	Eric Sklar (Safety Guru)/ Takayuki Nishimura (SCREEN Semiconductor Solution)		
Discussion:	None.		
Vote:	10-0. Motion passed.		
Motion:	Authorize the Letter Ballot for reapproval of S21-0818: Safety Guideline for Worker Protection in Cycle 4 or 5 of 2023		
By / 2 nd :	Eric Sklar (Safety Guru)/ Takayuki Nishimura (SCREEN Semiconductor Solution)		
Discussion:	None.		
Vote:	10-0. Motion passed.		

Action Item: EHS20230412-01, SEMI Staff to submit the Letter Ballot for reapproval of S21-0818: Safety Guideline for Worker Protection in Cycle 4 or 5.

Attachment: 05_SNARF_Reapproval_S21-0818_R1

7.3 Regulations Change Proposal Originated from the S23 Global TF 5-year Review

No proposal was made.

8 New Business

None.

9 Action Item Review

9.1 Open Action Items

Item #	Assigned to	Details
EHS20220908-02	JA & NA sides of Global Seismic TF leaders	To discuss the first Global TF meeting with NA Leader, Lauren Crane (Lam Research)->Open
EHS20221215-01	SEMI Staff	To prepare Reapproval SNARF for SEMI S21-0818: Safety Guideline for Worker Protection by the next TC meeting. ->Closed

9.2 New Action Items

Item #	Assigned to	Details
EHS20230412-01	SEMI Staff	To submit the Letter Ballot for reapproval of S21-0818: Safety Guideline for Worker Protection in Cycle 4 or 5.

10 Next Meeting and Adjournment

The next meeting is scheduled for Thursday, September 7, 2023 10:00-12:00 via OVTCCM and at SEMI Japan Office, Tokyo, Japan. See <u>http://www.semi.org/standards-events</u> for the current list of events.

Adjournment: [12:00].



Respectfully submitted by:

Akiko Yoshida

Standards & EHS

SEMI Japan

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Minutes tentatively approved by:

Supika Mashiro (Tokyo Electron), Co-chair	
Hidetoshi Sakura (NuFlare Technology), Co-chair	July 3, 2023
Moray Crawford (Hatsuta Seisakusho), Co-chair	July 3, 2023

Table 14 Index of Available Attachments^{#1}

Title	Title

#1 Due to file size and delivery issues, attachments must be downloaded separately. A .zip file containing all attachments for these minutes is available at www.semi.org. For additional information or to obtain individual attachments, please contact [SEMI Staff Name] at the contact information above.